

MATERIALS ENGINEERING LABORATORY DATA REPORT

PLENCO 04300

Two-Stage Phenolic compression molded

PLENCO 04300 is a heat resistant, mineral filled phenolic molding compound offering optimum cure characteristics and excellent dimensional stability. Customers have found this material useful for wiring devices and electrical control applications. UL recognized under component file E40654. 04300 is available in black. 04300 was qualified under military specification MIL-M-14 (superseded by ASTM D-5948) TYPE CFG and batches can, if requested and paid for, be tested for certification to the standard.

| PROPERTY | metric | english | ASTM Test Method |
|----------------------------------|------------------------|-------------------------|------------------|
| Form | Granular | | |
| Apparent Density | 0.72 g/cm ³ | 45.1 lb/ft ³ | D1895 |
| Specific Gravity | 1.57 | | D792 |
| Mold Shrinkage* | 0.0031 m/m | 0.0031 in/in | D6289 |
| Post Shrinkage 72hr 120°C | 0.13 % | | D6289 |
| Izod Impact Notched | 16.6 J/m | 0.31 ft·lb/in | D256 |
| Charpy Impact Notched | 20.3 J/m | 0.38 ft·lb/in | D256 |
| Drop Ball Impact | 96 J/m | 1.8 ft·lb/in | Plenco |
| Tensile Strength | 46 MPa | 6,679 psi | D638 |
| Tensile Modulus | 11,253 MPa | 1,632,000 psi | D638 |
| Tensile Elongation | 0.5 % | | D638 |
| Flexural Strength | 79.6 MPa | 11,548 psi | D790 |
| Flexural Modulus | 10,497 MPa | 1,522,000 psi | D790 |
| Compressive Strength | 194 MPa | 28,116 psi | D695 |
| Heat Resistance | 205 °C | 401 °F | D794 |
| Deflection Temperature 1.82MPa | 192 °C | 378 °F | D648 |
| Water Absorption | 0.19 % | | D570 |
| Rockwell Hardness | 84 E scale | | D785 |
| Dielectric Strength short time | 14.6 kV/mm | 370 V/mil | D149 |
| Dissipation Factor, 1MHz | 0.039 | | D150 |
| Permittivity, 1MHz | 5.1 | | D150 |
| Volume Resistivity | 1.9E+12 ohm·cm | 7.7E+11 ohm·in | D257 |
| ASTM Arc Resistance | 180 sec | | D495 |
| Comparative Tracking Index | 188 V | | D3638 |
| UL Flammability | V-0 @1.50mm | | UL 94 |
| Oxygen Index | 32.3 % | | D2863 |
| Coefficient of Thermal Expansion | 4.9E-05 /°C | 2.7E-05 /°F | E831 |
| Thermal Conductivity 100°C | 0.54 W/m°C | 0.31 Btu/hr/ft/°F | E1461 |

Prior to molding compression electrical specimens, material is dried 30 min @ 90C, 110C preheat.

ver 060915

Store in cool dry place.

The Typical Values listed are results obtained from the testing of standard specimens using the stated test procedures, with said specimens molded under controlled laboratory conditions from representative samplings of the product. Although Plastics Engineering Company at all times reserves the right to make changes in the materials, suppliers and processing, the values listed as typical are those to be expected at the time of our manufacture. The final determination of the accuracy or completeness of any information, the suitability of the product for the use contemplated, the manner of its use, and the matter of any infringement of patents in use, are all the sole responsibility of the user. PLASTICS ENGINEERING COMPANY MAKES NO WARRANTY, EXPRESS OR IMPLIED, WITH RESPECT TO THIS PRODUCT, INCLUDING NO WARRANTY OF THE MERCHANTABILITY OR OF FITNESS FOR A PARTICULAR PURPOSE. Plastics Engineering Company reserves at all times the right to discontinue the production of any or all of its products. This is an uncontrolled copy and not subject to updates.

**Mold Shrinkage obtained under controlled laboratory conditions with relatively simple mold geometry and should be used for comparison purposes only and not for actual tool design.*